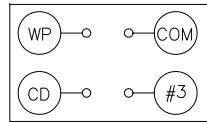
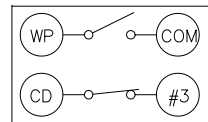


CIRCUIT WITHOUT CARD

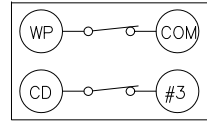


CARD INSERTED



●WRITE PROTECT SW. : LOCK  
●STATUS: READ ONLY

CARD INSERTED



●WRITE PROTECT SW. : UNLOCK  
●STATUS: WRITE ENABLE

Material:

Insulator: LCP+30% G.F., UL 94V-0 rated,Color Black.

Contact: Phosphor Bronze

Shield Cover:stainless steel sheet metal,SUS304,0.2t.

Contacts Plating:

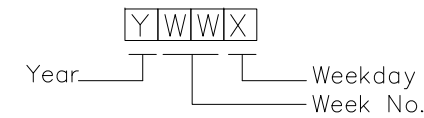
Contact Area: Gold Plating over1.27um(50u")min Ni underplate.

Soldering Zone: 3.5um(120u")min sn,over 1.27um(50u")min. Ni undreplate.

Gold plating in contact area:3u" and 15u" Gold Plating.

Shield Cover: Gold flash in soldering zone over Nickel under plating overall.

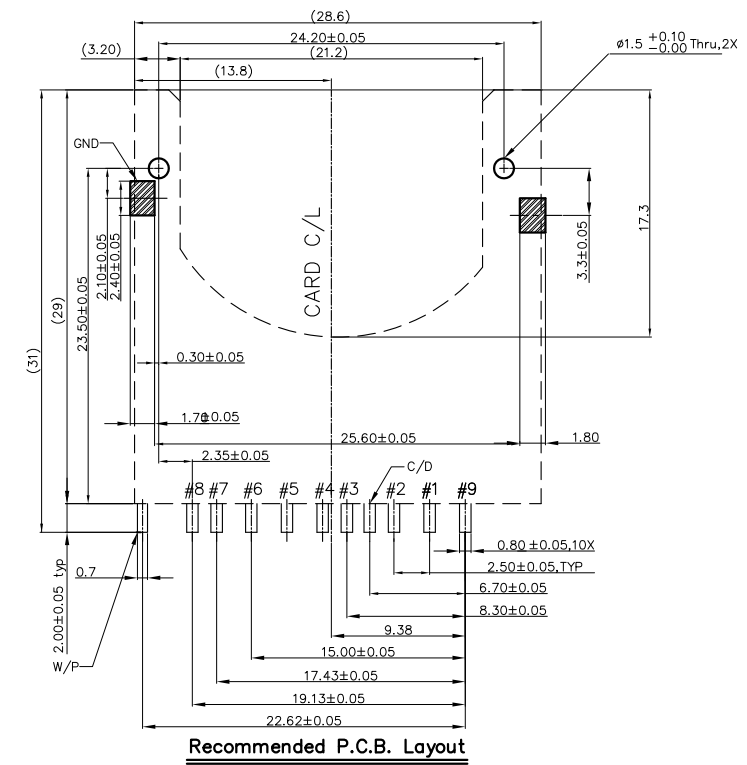
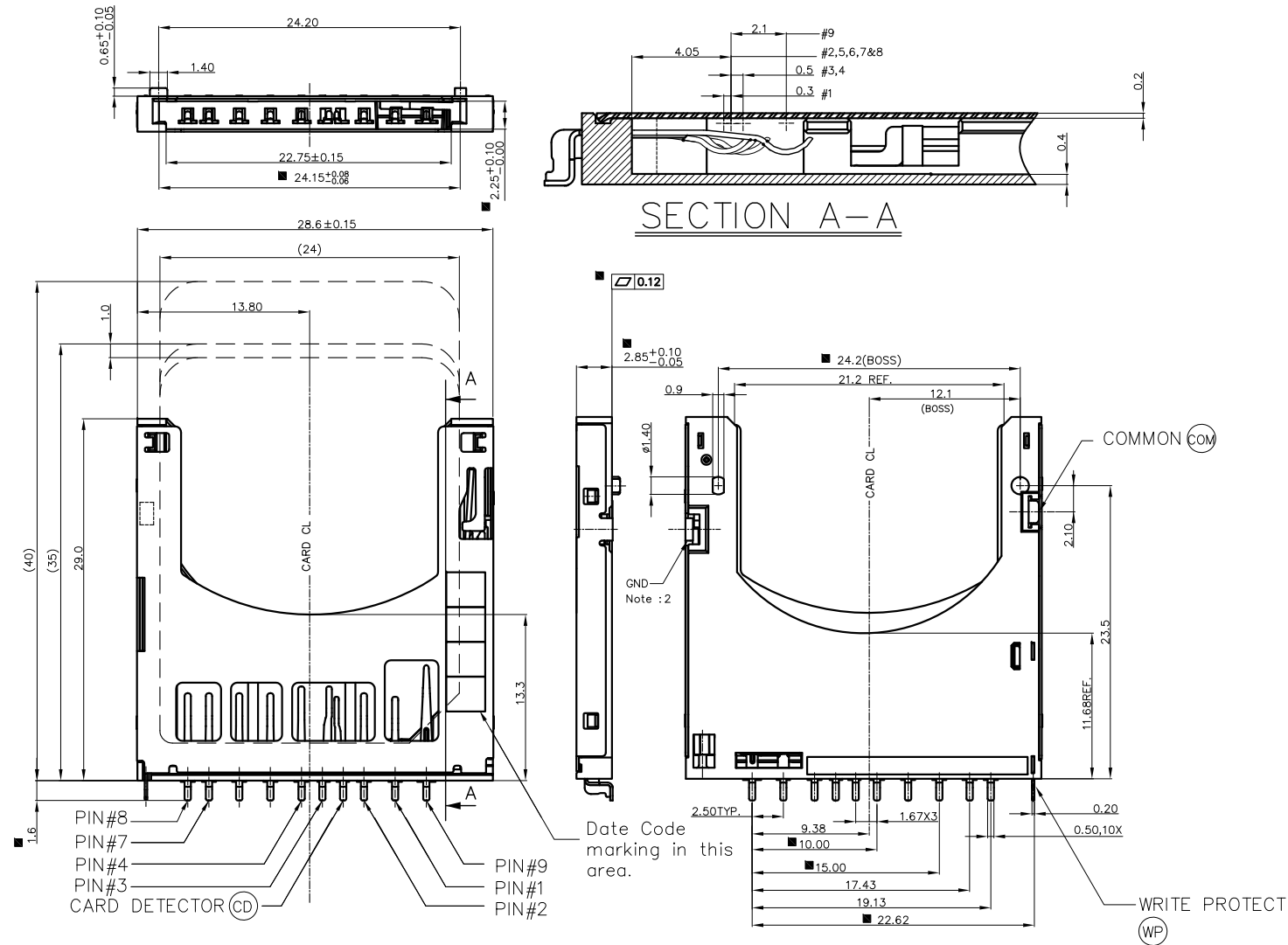
Date Code Marking:



104D-R X A 0-R01  
1 2 3 4

1.Type R:Reverse Mount 3.Stand Off A:0mm

2.Contact Plating A:15u"Gold Plating B:3u" Gold Plating 4.ROHS



						UNLESS OTHERWISE SPECIFIED TOLERANCE		 www.attend.com.tw		
						ANGLES	ANG.			±5°
						LINEAR	0.			±0.3
							0.0			±0.25
						SCALE	AS SHOWN	UNIT: mm		
						DRAWN	Willis	2012/08/03	DRAWN NAME: SD Socket Reverse Mount,Push-Push Type	
						CHECKED	Angel	2012/08/03		
						APPROVED	Ken	2012/08/03		
REV.	DESCRIPTION	DATE	REV.	DESCRIPTION	DATE	SIZE	A4	REV. 1.0	FILE NAME	104D-RXA0-R01_B_1
1			4							